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Electronic Patent Application Submission
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EFS ID: 63519

Application ID: 10749103



Title of Invention:

METHOD OF FORMING A MULTI-
LAYER SEMICONDUCTOR
STRUCTURE INCORPORATING A
PROCESSING HANDLE MEMBER

First Named Inventor: Rafael Reif

Domestic/Foreign Application: Domestic Application

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Statement

Filing Type:

Confirmation number: 3165

Attorney Docket Number: MIT-136BUS


Total Fees Authorized:

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TRANSMITTAL

Electronic Version v1.1
Stylesheet Version v1.1.0

Title of Invention	METHOD OF FORMING A MULTI-LAYER SEMICONDUCTOR STRUCTURE INCORPORATING A PROCESSING HANDLE MEMBER									
<p>Application Number: 10/749103 </p> <p>Date: 2003-12-30</p> <p>First Named Applicant: Rafael Reif</p> <p>Confirmation Number: 3165</p> <p>Attorney Docket Number: MIT-136BUS</p>										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Christopher S Daly Registered Number: 37,303</td><td>/csd/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Christopher S Daly Registered Number: 37,303	/csd/	Attorney		
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<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>MIT-136BUS-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	MIT-136BUS-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
us-ids	MIT-136BUS-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
Comments										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

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Invention

METHOD OF FORMING A MULTI-LAYER
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PROCESSING HANDLE MEMBER

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Confirmation Number: 3165

First Named Applicant: Rafael Reif

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Search string: (4313126 or 4402761 or 4456888 or 4599704
or 4986861 or 5156997 or 5206186 or 5445994
or 5821138 or 5923087 or 6441478).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	4313126	1982-01-26	Krumm et al.			
	2	4402761	1983-09-06	Feist			
	3	4456888	1984-01-26	Ayasli			
	4	4599704	1986-07-08	Mazin			
	5	4986861	1991-01-22	Nishida et al.			
	6	5156997	1992-10-20	Kumar et al.			
	7	5206186	1993-04-27	Neugebauer et al.			
	8	5445994	1995-08-29	Gilton			
	9	5821138	1998-10-13	Yamazaki et al.			
	10	5923087	1999-07-13	Suzuki et al.			
	11	6441478	2002-08-27	Park			

Signature

Examiner Name	Date